COM Express® Type 7



COME-C42-BT7 COM Express[®] Rel.3.0 Basic Type 7 module with the AMD EPYC[™] Embedded 3000 Series of SoCs

Scalable offerings with outstanding performance and more connectivity

	HIGHLIGHTS	HIGHLIGHTS		
	CPU AMD EPYC [™] Embedded	3000 family of SoCs	모 CONNECTIVITY 4x USB 3.1; 24x PCI-e Gen3 lanes	
	● E NETWORKING 4x 10GBASE-KR interfa	ces + 1x 1GbE port with No	C-SI MEMORY Four DDR4 SO-DIMM Slots supporting DDR4-2666 Memory with ECC, up to 128GB	
	Available in Industrial Tempera	() Available in Industrial Temperature Range		
The Windows 10 Windows Server 2016 Linux				
MAIN FIELDS OF APPLICATION				
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	Industrial Te Automation and	lco Server - H Performar	8	
FEATURES	Control	Computir		
	 AMD EPYC™ Embedded 3000 family of SoCs: AMD EPYC™ Embedded 3451, Sixteen Core Dual Thread @ 2.14GHz (3.0 Boost), 32MB L3 shared Cache, TDP 80-100W 	Security	Optional TPM 2.0 module on-board AMD Secure Processor for Crypto Co-processing Hardware Validated Boot capabilities Secure Memory Encryption	
	 AMD EPYC™ Embedded 3351, Twelve Core Dual Thread @ 1.9GHz (3.0 Boost), 32MB L3 shared Cache, TDD Co 2000 		Secure Encrypted Virtualization Multi-Stage Watchdog Timer	
	 TDP 60-80W AMD EPYC[™] Embedded 3251, Eight Core Dual Thread @ 2.5GHz (3.1 Boost), 16MB L3 shared Cache, TDP 55W 		2x I2C Advanced FAN management	
Processor	 AMD EPYC[™] Embedded 3201, Eight Core Single Thread @ 1.5GHz (3.1 Boost), 16MB L3 shared Cache, TDP 30W 	Controller	4x GPI, 4 x GPO Power State Management Hardware and temperature monitoring	
	 AMD EPYCT^M Embedded 3151, Quad Core Dual Thread @ 2.7GHz (2.9 Boost), 16MB L3 shared Cache, TDP 45W AMD EPYCT^M Embedded 3101, Our Care, Empedded 		User Data Storage	
	 AMD EPYC™ Embedded 3101, Quad Core Single Thread @ 2.1GHz (2.9 Boost), 8MB L3 shared Cache, TDP 35W AMD EPYC™ Embedded 3255, Eight Core Dual Thread 	BIOS	Board statistics: up-time, boot counter, reset cause log Dedicated embedded BIOS based on AMI Aptio V	
	@ 2.5GHz (3.1 Boost), 16MB L3 shared Cache, TDP 55W, industrial grade	Power	·	
A Memory	Up to 4x DDR4 SO-DIMM Slots supporting DDR4-2666 Memory (both ECC and not-ECC supported), up to 128GB	ouppiy	$+12V_{_{DC}} \pm 10\%$ and $+5V_{_{SB}}$ (optional) Microsoft® Windows 10	
Diass Storage	2x S-ATA Gen3 Channels	Operating System	Microsoft® Windows Server 2016 Linux OS 64-bit	
	1x Gigabit Ethernet LAN port with NC-SI (Network Controller Sideband Interface) functionality, managed by	Temperature*	0°C ÷ +60°C (Commercial version) -40°÷+85°C (Industrial Range, when available)	
귬노 Networking	 an Intel® I210 Gigabit Ethernet Controller 4x 10Gigabit Ethernet interfaces (10GBASE-KR), directly managed by the EPYC[™] SoCs 	L Dimensions	125mm x 95mm	
⊷ USB	4 x USB 3.1 Host ports (SS + USB 2.0 interfaces)	*Measured at any point of SECO standard heatspreader for this product, during any and all times (including start-up). Actual temperature will widely depend on application, enclosure and/or environment. Upon customer to consider application- specific cooling solutions for the final system to keep the heatspreader temperature in the range indicated.		
E PCI-e	24x PCI-e Gen3 lanes			
📟 Serial Ports	2x legacy UARTs, 16C550 compatible			
Other Interfaces	SPI, SM Bus, LPC bus			



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BLOCK DIAGRAM





